

HALOGEN FREE

Silicon PIN Photodiode



DESCRIPTION

VBP104S and VBP104SR are high speed and high sensitive PIN photodiodes. It is a surface mount device (SMD) including the chip with a 4.4 mm² sensitive area detecting visible and near infrared radiation.

FEATURES

- Package type: surface mount
- Package form: GW, RGW



- Radiant sensitive area (in mm²): 4.4
- · High photo sensitivity
- · High radiant sensitivity
- · Suitable for visible and near infrared radiation
- Fast response times
- Angle of half sensitivity: $\varphi = \pm 65^{\circ}$
- Floor life: 168 h, MSL 3, acc. J-STD-020
- · Lead (Pb)-free reflow soldering
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition

APPLICATIONS

• High speed photo detector

| PRODUCT SUMMARY | | | | |
|-----------------|----------------------|---------|-----------------------|--|
| COMPONENT | I _{ra} (μΑ) | φ (deg) | λ _{0.1} (nm) | |
| VBP104S | 35 | ± 65 | 430 to 1100 | |
| VBP104SR | 35 | ± 65 | 430 to 1100 | |

Note

• Test conditions see table "Basic Characteristics"

| ORDERING INFORMATION | | | | | |
|----------------------|---------------|------------------------------|------------------|--|--|
| ORDERING CODE | PACKAGING | REMARKS | PACKAGE FORM | | |
| VBP104S | Tape and reel | MOQ: 1000 pcs, 1000 pcs/reel | Gullwing | | |
| VBP104SR | Tape and reel | MOQ: 1000 pcs, 1000 pcs/reel | Reverse gullwing | | |

Note

· MOQ: minimum order quantity

| ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified) | | | | | |
|--|-----------------------------------|-------------------|---------------|------|--|
| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT | |
| Reverse voltage | | V _R | 60 | V | |
| Power dissipation | T _{amb} ≤ 25 °C | P _V | 215 | mW | |
| Junction temperature | | Tj | 100 | °C | |
| Operating temperature range | | T _{amb} | - 40 to + 100 | °C | |
| Storage temperature range | | T _{stg} | - 40 to + 100 | °C | |
| Soldering temperature | Acc. reflow solder profile fig. 8 | T _{sd} | 260 | °C | |
| Thermal resistance junction/ambient | | R _{thJA} | 350 | K/W | |



| BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified) | | | | | | |
|---|--|-------------------|------|-----------------------|------|-------|
| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| Forward voltage | I _F = 50 mA | V _F | | 1 | 1.3 | V |
| Breakdown voltage | $I_R = 100 \ \mu A, E = 0$ | V _(BR) | 60 | | | V |
| Reverse dark current | V _R = 10 V, E = 0 | I _{ro} | | 2 | 30 | nA |
| Diada assas Manas | V _R = 0 V, f = 1 MHz, E = 0 | C _D | | 48 | | pF |
| Diode capacitance | V _R = 3 V, f = 1 MHz, E = 0 | C _D | | 17 | 40 | pF |
| Open circuit voltage | $E_e = 1 \text{ mW/cm}^2, \lambda = 950 \text{ nm}$ | Vo | | 350 | | mV |
| Temperature coefficient of Vo | $E_e = 1 \text{ mW/cm}^2, \lambda = 950 \text{ nm}$ | TK _{Vo} | | - 2.6 | | mV/K |
| Short circuit current | $E_e = 1 \text{ mW/cm}^2, \lambda = 950 \text{ nm}$ | I _k | | 32 | | μA |
| Temperature coefficient of Ik | $E_e = 1 \text{ mW/cm}^2, \lambda = 950 \text{ nm}$ | TK _{lk} | | 0.1 | | %/K |
| Reverse light current | E_e = 1 mW/cm ² , λ = 950 nm, V_R = 5 V | I _{ra} | 25 | 35 | | μΑ |
| Angle of half sensitivity | | φ | | ± 65 | | deg |
| Wavelength of peak sensitivity | | λ_{p} | | 940 | | nm |
| Range of spectral bandwidth | | λ _{0.1} | | 430 to 1100 | | nm |
| Noise equivalent power | V _R = 10 V, λ = 950 nm | NEP | | 4 x 10 ⁻¹⁴ | | W/√Hz |
| Rise time | $V_R = 10 \text{ V}, R_L = 1 \text{ k}\Omega,$ $\lambda = 820 \text{ nm}$ | t _r | | 100 | | ns |
| Fall time | V_R = 10 V, R_L = 1 k Ω , λ = 820 nm | t _f | | 100 | | ns |

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

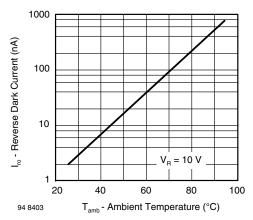


Fig. 1 - Reverse Dark Current vs. Ambient Temperature

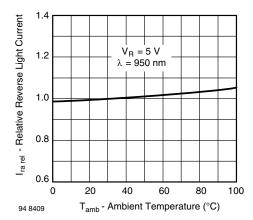


Fig. 2 - Relative Reverse Light Current vs. Ambient Temperature



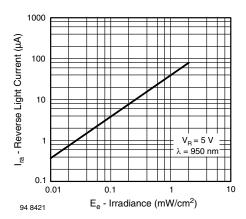


Fig. 3 - Reverse Light Current vs. Irradiance

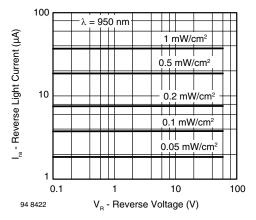


Fig. 4 - Reverse Light Current vs. Reverse Voltage

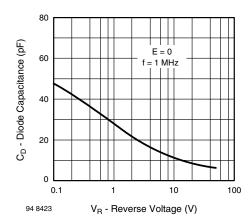


Fig. 5 - Diode Capacitance vs. Reverse Voltage

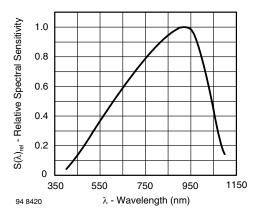


Fig. 6 - Relative Spectral Sensitivity vs. Wavelength

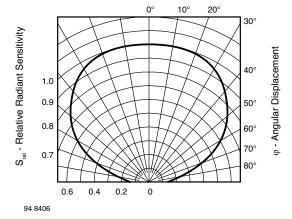
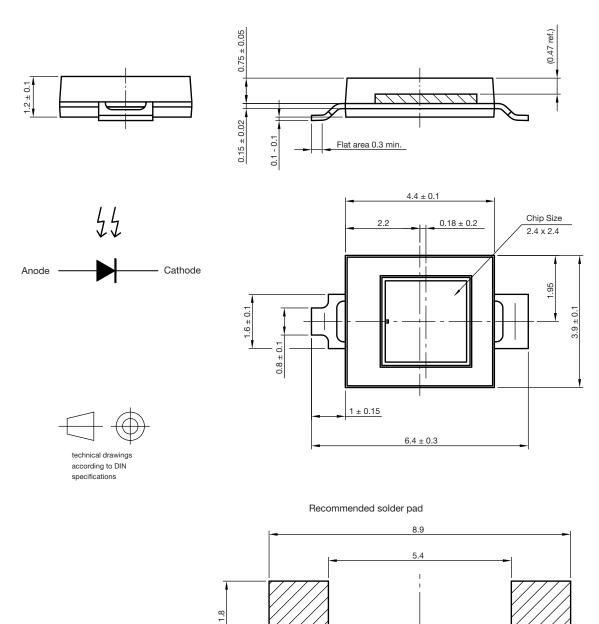


Fig. 7 - Relative Radiant Sensitivity vs. Angular Displacement

PACKAGE DIMENSIONS FOR VBP104S in millimeters

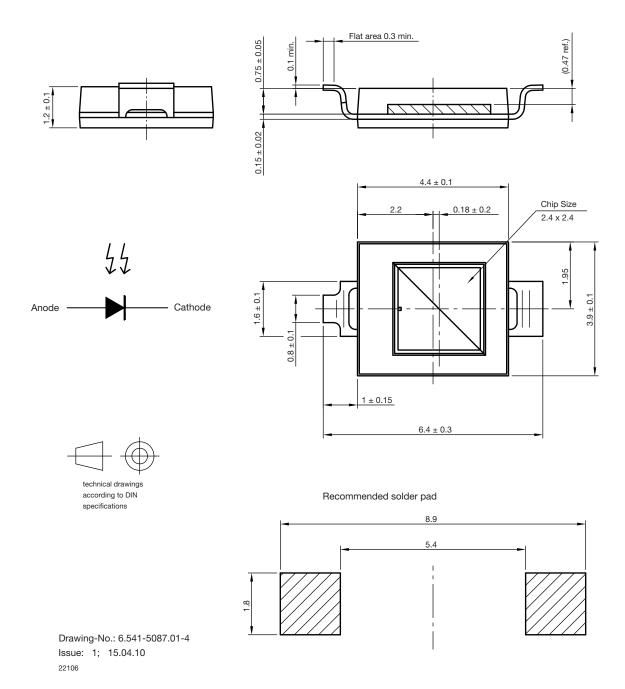


Drawing-No.: 6.541-5088.01-4

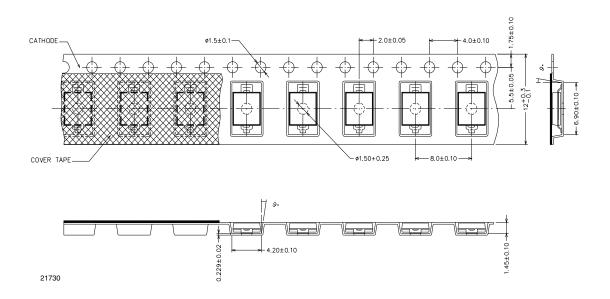
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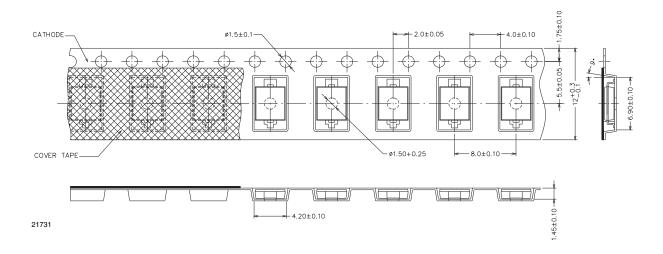
PACKAGE DIMENSIONS FOR VBP104SR in millimeters



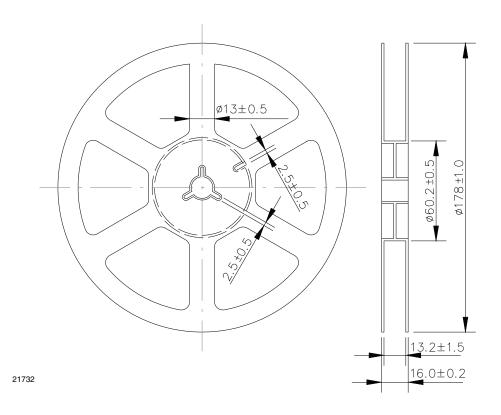
TAPING DIMENSIONS FOR VBP104S in millimeters



TAPING DIMENSIONS FOR VBP104SR in millimeters



REEL DIMENSIONS FOR VBP104S AND VBP104SR in millimeters



SOLDER PROFILE

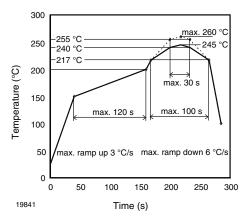


Fig. 8 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Time between soldering and removing from MBB must not exceed the time indicated in J-STD-020:

Moisture sensitivity: level 3

Floor life: 168 h

Conditions: T_{amb} < 30 °C, RH < 60 %

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or recommended conditions:

192 h at 40 °C (+ 5 °C), RH < 5 %

or

96 h at 60 °C (+ 5 °C), RH < 5 %.



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